

L Number	Hits	Search Text	DB	Time stamp
5	44	(transfer near3 (mechanism or arm)) same (cover near2 body)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 16:08
6	22	(wafer near3 (holder or arm)) same (cover near2 body)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:32
7	0	(wafer near3 (holder or arm)) and (tokyo.asn)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:04
8	1266	(wafer near3 (holder or arm)) and (tokyo.asn.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 16:11
9	884	(414/935).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:54
10	420	(414/936).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:17
11	727	(414/937).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:17
12	313	(414/938).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:17
13	671	(414/939).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:17
14	747	(414/940).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 18:46
15	487	(414/941).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:18
16	26	(((414/935).CCLS.) ((414/936).CCLS.) ((414/937).CCLS.) ((414/938).CCLS.) ((414/939).CCLS.) ((414/940).CCLS.) ((414/941).CCLS.)) and (cover near2 body)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:27

17	23	(((414/935).CCLS.) ((414/936).CCLS.) ((414/937).CCLS.) ((414/938).CCLS.) ((414/939).CCLS.) ((414/940).CCLS.) ((414/941).CCLS.)) and (cover near2 arm)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:53
18	3	("5664254").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 18:08
21	17	414/\$.ccls. and ((wafer near3 (holder or arm)) near5 (cover))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:35
22	17	((wafer near3 (holder or arm)) near5 (cover))	JPO	2004/08/03 17:36
23	61	tokyo.asn. and (cover near2 arm)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:53
24	521	tokyo.asn. and (cover near2 body)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 18:18
25	283	(414/414).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 18:06
26	2	("5772386").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 18:08
27	33	IIDA.in. and NARIAKI.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 18:19
28	335	(134/95.2).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:03
29	142	(134/102.3).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:03
30	616	(134/113).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:03
31	974	(transfer near3 (mechanism or arm)) near12 (clean or cleaning)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:04

32	4470	(wafer near3 (holder or arm)) and (clean or cleaning)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:05
34	0	((transfer near3 (mechanism or arm)) near12 (ccd or camera)) and (stain near4 detect\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:05
35	3	(transfer near3 (mechanism or arm)) near12 (stain near4 detect\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:05
36	1	(wafer near3 (holder or arm)) near12 (stain near4 detect\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:05
37	0	(wafer near3 (holder or arm)) near12 (deposit near4 detect\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:05
33	105	(transfer near3 (mechanism or arm)) near12 (clean or cleaning) and 134/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:06
-	0	204/\$.ccls. and module and (vacuum\$1 near2 chamber\$1) and (spin near2 coat)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:27
-	0	134/\$.ccls. and module and (vacuum\$1 near2 chamber\$1) and (spin near2 coat)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 17:01
-	0	118/\$.ccls. and module and ((low near2 pressure)) and (spin near2 coat)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:27
-	1	("6112430").PN.	USPAT	2004/07/31 21:27
-	0	"302521"	JPO	2004/07/31 21:27
-	0	"9164364"	JPO	2004/07/31 21:27
-	0	"164364"	JPO	2004/07/31 21:27
-	0	"10364943"	JPO	2004/07/31 21:27
-	0	@pd=19980619 and (slender near2 stream)	JPO	2004/07/31 21:27
-	0	@pd=19980619 and (film near2 apparatus)	JPO	2004/07/31 21:27
-	0	@pd=19980619 and (film near2 apparatus)	JPO	2004/07/31 21:27
-	0	@pd=1998 and (toyko and ohka and kogyo)	JPO	2004/07/31 21:27
-	0	toyko and ohka and kogyo	JPO	2004/07/31 21:27
-	0	"11312659"	JPO	2004/07/31 21:28
-	188	(118/713).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:29

-	522	(118/56).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:29
-	72	118/\$.ccls. and tokyo.asn. and humidity	USPAT	2004/07/31 21:29
-	151	118/\$.ccls. and tokyo.asn. and (reduced near2 pressure)	USPAT	2004/08/01 16:42
-	1	("6261007").PN.	USPAT	2004/07/31 21:29
-	91	118/\$.ccls. and (vacuum near2 dry)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:29
-	1239	(118/52).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/01 18:35
-	141	(118/676).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:29
-	226	(118/669).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:29
-	188	(118/713).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 17:17
-	1988	(118/50).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:30
-	607	(118/301).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:30
-	2164	(134/902).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	3	438/\$.ccls. and module and (vacuum\$1 near2 chamber\$1) and (spin near2 coat)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	2	118/\$.ccls. and module and (vacuum\$1 near2 chamber\$1) and (spin near2 coat)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	3	134/\$.ccls. and module and (vacuum\$1 near2 chamber\$1) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31

-	17	118/\$.ccls. and module and ((low near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	10	134/\$.ccls. and module and ((low near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	5	204/\$.ccls. and module and ((low near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	109	438/\$.ccls. and module and ((low near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	62	438/\$.ccls. and module and ((reduced near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	128	438/\$.ccls. and modul\$ and ((reduced near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	16	118/\$.ccls. and modul\$ and ((reduced near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	14	134/\$.ccls. and modul\$ and ((reduced near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	15	204/\$.ccls. and modul\$ and ((reduced near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	203	(396/611).CCLS.	USPAT	2004/07/31 21:31
-	302	(396/604).CCLS.	USPAT	2004/07/31 21:31
-	11	396/\$.ccls. and modul\$ and ((reduced near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	3	396/\$.ccls. and modul\$ and ((low near2 pressure)) and (spin\$ near2 coat\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/31 21:31
-	5	"6261007"	USPAT	2004/07/31 21:31
-	1	"5641541".PN.	USPAT	2004/07/31 21:31
-	1	"5670210".PN.	USPAT	2004/08/01 19:31
-	1	"6112430".PN.	USPAT	2004/07/31 21:31
-	1	"63302521"	JPO	2004/07/31 21:31
-	1	"09164364"	JPO	2004/07/31 21:31
-	1	"63010528"	JPO	2004/07/31 21:31
-	1	"09002113"	JPO	2004/07/31 21:31

-	1	"09002114"	JPO	2004/07/31 21:31
-	24	"5779799"	USPAT	2004/07/31 21:31
-	2	"10173229"	JPO	2004/07/31 21:31
-	1	"6063190".PN.	USPAT	2004/07/31 21:31
-	1	"6033480".PN.	USPAT	2004/07/31 21:31
-	1	"5804046".PN.	USPAT	2004/07/31 21:31
-	1	"5662785".PN.	USPAT	2004/07/31 21:31
-	1	"5662785".PN.	USPAT	2004/07/31 21:31
-	1	"5578127".PN.	USPAT	2004/07/31 21:31
-	1	"5059266".PN.	USPAT	2004/07/31 21:31
-	1	"4633804".PN.	USPAT	2004/07/31 21:31
-	5	"6159541"	USPAT	2004/07/31 21:31
-	3	"11259895" or "11260431"	JPO	2004/07/31 21:31
-	1	"10163229"	JPO	2004/07/31 21:33
-	127	118/\$.ccls. and tokyo.asn. and (low near2 pressure)	USPAT	2004/08/01 19:32
-	73	drying near10 (reduced near2 pressure) and tokyo.asn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/01 16:57
-	8	drying near10 (low near2 pressure) and tokyo.asn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/01 16:58
-	11	drying near10 (low near2 pressure) and (photoresist near3 coat\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/01 16:59
-	52	drying near10 (reduced near2 pressure) and (photoresist near3 coat\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/01 19:33
-	297	tokyo.asn. and adhesion and 118/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 14:52
-	0	tokyo.asn. and ((reduced near2 pressue) near10 unit) and 118/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 14:53
-	31	tokyo.asn. and ((reduced near2 pressure) near10 unit) and 118/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 14:58
-	0	6599366.URPN.	USPAT	2004/08/02 14:55
-	7	("5919332" "5964947" "5976256" "6009827" "6143128" "6263587" "6423642").PN.	USPAT	2004/08/02 14:55
-	47	(semiconductor near2 wafer) and ((reduced near2 pressure) near10 unit) and 118/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 15:16
-	2	(semiconductor near2 wafer) and ((reduced near2 pressure) near10 unit) and (CVD) and (photoresist)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 16:27

-	15	(semiconductor near2 wafer) and ((reduced near2 pressure) near10 unit) and (SOG or photoresist)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 16:47
-	64	134/\$.ccls. and module and (transfer near3 (mechanism or arm))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 19:47
-	0	118/\$.ccls. and (cluster near4 tool) and (transfer near3 (mechanism or arm)) and (atmosphere near10 control)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 20:16
-	1	(cluster near4 tool) and (transfer near3 (mechanism or arm)) and (atmosphere near10 control)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 19:48
-	19	(cluster near4 tool) and (atmosphere near10 control)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 19:49
-	319	(transfer near3 (mechanism or arm)) and (atmosphere near10 control)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/02 20:16
-	43	(transfer near3 (mechanism or arm)) and (atmosphere near10 control) and (tokyo.asn.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/03 20:03